

### **General Description**

The MAX6646/MAX6647/MAX6649 are precise, twochannel digital temperature sensors. The devices accurately measure the temperature of their own die and a remote PN junction, and report the temperature in digital form using a 2-wire serial interface. The remote PN junction is typically the emitter-base junction of a commoncollector PNP on a CPU, FPGA, or ASIC.

The 2-wire serial interface accepts standard system management bus (SMBus<sup>TM</sup>) write byte, read byte, send byte, and receive byte commands to read the temperature data and to program the alarm thresholds. To enhance system reliability, the MAX6646/MAX6647/MAX6649 include an SMBus timeout. A fault queue prevents the ALERT and OVERT outputs from setting until a fault has been detected one, two, or three consecutive times (programmable).

The MAX6646/MAX6647/MAX6649 provide two system alarms: ALERT and OVERT. ALERT asserts when any of four temperature conditions are violated: local overtemperature, remote overtemperature, local undertemperature, or remote undertemperature. OVERT asserts when the temperature rises above the value in either of the two OVERT limit registers. The OVERT output can be used to activate a cooling fan, or to trigger a system shutdown.

Measurements can be done autonomously, at the programmed conversion rate, or in a single-shot mode. The adjustable conversion rate allows optimizing supply current and temperature update rate to match system needs.

Remote accuracy is ±1°C maximum error between +60°C and +145°C with no calibration needed. The MAX6646/ MAX6647/MAX6649 operate from -55°C to +125°C, and measure temperatures between 0°C and +145°C. The MAX6646/MAX6647/MAX6649 are available in an 8-pin µMAX® package.

### **Applications**

**Graphics Processors** 

**Desktop Computers** 

Notebook Computers

Servers

Thin Clients

Workstations

Test and Measurement

Multichip Modules

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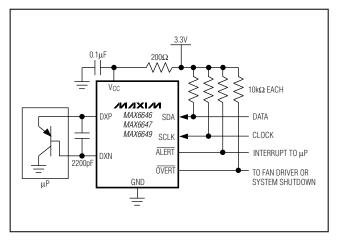
#### Features

- ♦ Dual Channel: Measures Remote and Local **Temperature**
- ♦ 0.125°C Resolution
- ♦ High Accuracy ±1°C (max) from +60°C to +145°C (Remote), and ±2°C (max) from +60°C to +100°C (Local)
- ♦ Measures High-Ideality Thermal Diodes Up to
  - +170°C (Apparent)
  - +145°C (Real)
- ♦ Two Alarm Outputs: ALERT and OVERT
- ♦ Programmable Under/Overtemperature Alarm **Temperature Thresholds**
- **♦ Programmable Conversion Rate**
- **♦ SMBus-Compatible Interface**
- **♦ SMBus Timeout**

### **Ordering Information**

| PART       | TEMP RANGE      | PIN-<br>PACKAGE | MEASURED<br>TEMP RANGE |
|------------|-----------------|-----------------|------------------------|
| MAX6646MUA | -55°C to +125°C | 8 µMAX          | 0°C to +145°C          |
| MAX6647MUA | -55°C to +125°C | 8 µMAX          | 0°C to +145°C          |
| MAX6649MUA | -55°C to +125°C | 8 µMAX          | 0°C to +145°C          |

### **Typical Operating Circuit**



Selector Guide, Pin Configurations, and Functional Diagram appear at end of data sheet.

MIXIM

Maxim Integrated Products 1

#### **ABSOLUTE MAXIMUM RATINGS**

| All Voltages Referenced to GND            |                           |
|---|---------------------------|
| V <sub>C</sub> C                          | 0.3V to +6V               |
| DXP                                       | 0.3V to $(V_{CC} + 0.3V)$ |
| DXN                                       | 0.3V to +0.8V             |
| SCLK, SDA, ALERT, OVERT                   | 0.3V to +6V               |
| SDA, ALERT, OVERT Current                 | 1mA to +50mA              |
| DXN Current                               | ±1mA                      |
| Continuous Power Dissipation ( $T_A = +7$ | '0°C)                     |
| 8-Pin µMAX (derate 4.8mW/°C above         | e +70°C)387.8mW           |

| ESD Protection (all pins, Human Body Model) | )±2000V        |
|---|----------------|
| Junction Temperature                        | +150°C         |
| Operating Temperature Range                 | 55°C to +125°C |
| Storage Temperature Range                   |                |
| Lead Temperature (soldering, 10s)           | +300°C         |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = 3.0 \text{V to } 5.5 \text{V}, T_A = -55 ^{\circ}\text{C} \text{ to } + 125 ^{\circ}\text{C}, \text{ unless otherwise specified.}$  Typical values are at  $V_{CC} = 3.3 \text{V}$  and  $T_A = +100 ^{\circ}\text{C}.)$  (Note 1)

| PARAMETER                                | SYMBOL          | CONDITIONS  |  | MIN   | TYP  | MAX  | UNITS |
|--|-----------------|---|--|-------|------|------|-------|
| Supply Voltage                           | Vcc             |   |  | 3.0   |      | 5.5  | V     |
| Tananavatura Danakutian                  |                 |   |  | 0.125 |      |      | °C    |
| Temperature Resolution                   |                 |   |  |       | 11   |      | Bits  |
|  |                 | $V_{CC} = 3.3V, T_A = T_{RJ} = +60^{\circ}C \text{ to } +$    |  | -1.0  |      | +1.0 |       |
| Remote Temperature Error                 |                 | $V_{CC} = 3.3V, T_A = T_{RJ} = +25^{\circ}C \text{ to } +$    | +60°C to +100°C,<br>145°C                      | -1.6  |      | +1.6 | °C    |
|  |                 | $V_{CC} = 3.3V, T_A = T_{RJ} = +0^{\circ}C \text{ to } +1.00$ |  | -3.2  |      | +3.2 |       |
| Local Tamanayatura Furar                 |                 | \/ 0.0\/  | $T_A = +60^{\circ}C \text{ to } +100^{\circ}C$ | -2.0  |      | +2.0 | °C    |
| Local Temperature Error                  |                 | $V_{CC} = 3.3V$   | $T_A = 0$ °C to $+125$ °C                      | -3.0  |      | +3.0 |       |
| Supply Sensitivity of Temperature Error  |                 |   |  |       | ±0.2 |      | °C/V  |
| Undervoltage Lockout (UVLO)<br>Threshold | UVLO            | Falling edge of V <sub>CC</sub> disables ADC                  |  | 2.4   | 2.7  | 2.95 | V     |
| UVLO Hysteresis                          |                 |   |  |       | 90   |      | mV    |
| Power-On-Reset (POR) Threshold           |                 | V <sub>CC</sub> falling edge                                  |  |       | 2.0  |      | V     |
| POR Threshold Hysteresis                 |                 |   |  |       | 90   |      | mV    |
| Standby Supply Current                   |                 | SMBus static  |  |       | 3    | 12   | μΑ    |
| Operating Current                        |                 | During conversion   | n  |       |      | 0.08 | mA    |
| Average Operating Current                |                 | 0.25 conversions  | per second                                     |       | 40   | 80   |       |
| Average Operating Current                |                 | 2 conversions per second                                      |  |       | 250  | 400  | μΑ    |
| Conversion Time                          | tconv           | From stop bit to conversion completion                        |  | 95    | 125  | 156  | ms    |
| Conversion Time Error                    |                 |   |  | -25   |      | +25  | %     |
| DXP and DXN Leakage Current              |                 | Standby mode  |  |       |      | 100  | nA    |
| Remote-Diode Source Current              | lo i            | High level  |  | 80    | 100  | 120  |       |
| Themote-blode Source Current             | I <sub>RJ</sub> | Low level   |  | 8     | 10   | 12   | μΑ    |

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC} = 3.0 \text{V to } 5.5 \text{V}, T_{A} = -55 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}, \text{ unless otherwise specified.}$  Typical values are at  $V_{CC} = 3.3 \text{V}$  and  $T_{A} = +100 ^{\circ}\text{C}.)$  (Note 1)

| PARAMETER                                      | SYMBOL           | CONDITIONS                               | MIN      | TYP | MAX | UNITS |
|--|------------------|--|----------|-----|-----|-------|
| ALERT, OVERT                                   |                  |  | <u> </u> |     |     |       |
| Output Law Valtage                             |                  | I <sub>SINK</sub> = 1mA                  |          |     | 0.4 | V     |
| Output Low Voltage                             |                  | I <sub>SINK</sub> = 4mA                  |          |     | 0.6 | V     |
| Output High Leakage Current                    |                  | V <sub>OH</sub> = 5.5V                   |          |     | 1   | μΑ    |
| SMBus-COMPATIBLE INTERFAC                      | E (SCLK AN       | D SDA)                                   |          |     |     |       |
| Logic Input Low Voltage                        | VIL              |  |          |     | 0.8 | V     |
| Logic Input High Voltage                       | VIH              | V <sub>CC</sub> = 3.0V                   | 2.2      |     |     | V     |
| Logic Input High Voltage                       | VIH              | V <sub>CC</sub> = 5.5V                   | 2.6      |     |     | V     |
| Input Leakage Current                          | ILEAK            | V <sub>IN</sub> = GND or V <sub>CC</sub> | -1       |     | +1  | μΑ    |
| Output Low-Sink Current                        | ISINK            | $V_{OL} = 0.6V$                          | 6        |     |     | mA    |
| Input Capacitance                              | CIN              |  |          | 5   |     | рF    |
| SMBus-COMPATIBLE TIMING (N                     | ote 2)           |  |          |     |     |       |
| Serial Clock Frequency                         | fsclk            | (Note 3)                                 |          |     | 100 | kHz   |
| Bus Free Time Between STOP and START Condition | tBUF             |  | 4.7      |     |     | μs    |
| START Condition Setup Time                     |                  |  | 4.7      |     |     | μs    |
| Repeat START Condition Setup<br>Time           | tsu:sta          | 90% to 90%                               | 50       |     |     | ns    |
| START Condition Hold Time                      | thd:sta          | 10% of SDA to 90% of SCLK                | 4        |     |     | μs    |
| STOP Condition Setup Time                      | tsu:sto          | 90% of SCLK to 90% of SDA                | 4        |     |     | μs    |
| Clock Low Period                               | t <sub>LOW</sub> | 10% to 10%                               | 4.7      |     |     | μs    |
| Clock High Period                              | tHIGH            | 90% to 90%                               | 4        |     |     | μs    |
| Data Setup Time                                | thd:dat          | (Note 4)                                 | 250      |     |     | μs    |
| Receive SCLK/SDA Rise Time                     | t <sub>R</sub>   |  |          |     | 1   | μs    |
| Receive SCLK/SDA Fall Time                     | tF               |  |          |     | 300 | ns    |
| Pulse Width of Spike Suppressed                | tsp              |  | 0        |     | 50  | ns    |
| SMBus Timeout                                  | tTIMEOUT         | SDA low period for interface reset       | 25       | 37  | 55  | ms    |

Note 1: All parameters tested at a single temperature. Specifications over temperature are guaranteed by design.

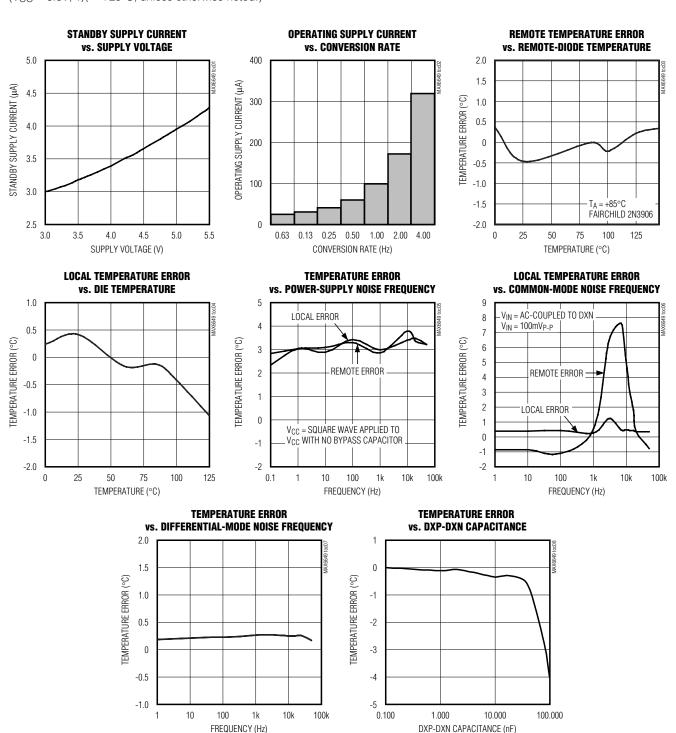
Note 2: Timing specifications guaranteed by design.

**Note 3:** The serial interface resets when SCLK is low for more than t<sub>TIMEOUT</sub>.

Note 4: A transition must internally provide at least a hold time to bridge the undefined region (300ns max) of SCLK's falling edge.

**Typical Operating Characteristics** 

 $(V_{CC} = 3.3V, T_A = +25^{\circ}C, unless otherwise noted.)$ 



### **Pin Description**

| PIN | NAME            | FUNCTION   |
|-----|-----------------|--|
| 1   | V <sub>CC</sub> | Supply Voltage Input, 3V to 5.5V. Bypass $V_{CC}$ to GND with a $0.1\mu F$ capacitor. A $200\Omega$ series resistor is recommended but not required for additional noise filtering.  |
| 2   | DXP             | Combined Remote-Diode Current Source and A/D Positive Input for Remote-Diode Channel. <b>DO NOT LEAVE DXP FLOATING</b> ; connect DXP to DXN if no remote diode is used. Place a 2200pF capacitor between DXP and DXN for noise filtering.  |
| 3   | DXN             | Combined Remote-Diode Current Sink and A/D Negative Input. DXN is internally connected to ground.  |
| 4   | OVERT           | Overtemperature Alert/Interrupt Output, Open Drain. OVERT is logic low when the temperature is above the software-programmed threshold.  |
| 5   | GND             | Ground   |
| 6   | ALERT           | SMBus Alert (Interrupt) Output, Open Drain. ALERT asserts when temperature exceeds limits (high or low temperature). ALERT stays asserted until acknowledged by either reading the status register or by successfully responding to an alert response address, provided that the fault condition no longer exists. See the ALERT Interrupts section. |
| 7   | SDA             | SMBus Serial-Data Input/Output, Open Drain   |
| 8   | SCLK            | SMBus Serial-Clock Input   |

### Detailed Description

The MAX6646/MAX6647/MAX6649 are temperature sensors designed to work in conjunction with a microprocessor or other intelligence in thermostatic, process-control, or monitoring applications. Communication with the MAX6646/MAX6647/MAX6649 occurs through the SMBus-compatible serial interface and dedicated alert and overtemperature outputs. ALERT asserts if the measured local or remote temperature is greater than the software-programmed ALERT high limit or less than the ALERT low limit in the MAX6649. ALERT also asserts, in the MAX6649, if the remote-sensing diode pins are shorted or unconnected. The overtemperature alarm, OVERT, asserts if the software-programmed OVERT limit is exceeded. OVERT can be connected to fans, a system shutdown, a clock throttle control, or other thermal-management circuitry.

The MAX6646/MAX6647/MAX6649 convert temperatures to digital data either at a programmed rate or in single conversions. Temperature data is represented as 11 bits, with the LSB equal to 0.125°C. The "main" temperature data registers (at addresses 00h and 01h) are 8-bit registers that represent the data as 8 bits with the full-scale reading indicating the diode fault status (Table 1). The remaining 3 bits of temperature data are available in the "extended" registers at addresses 11h and 10h (Table 2).

#### **ADC and Multiplexer**

The averaging ADC integrates over a 60ms period (each channel, typically), with excellent noise rejection. The multiplexer automatically steers bias currents through the remote and local diodes. The ADC and associated circuitry measure each diode's forward voltage and compute the temperature based on this voltage. Both channels are automatically converted once the conversion process has started, either in free-running or single-shot mode. If one of the two channels is not used, the device still performs both measurements, and the results of the unused channel can be ignored. If the remote-diode channel is unused, connect DXP to DXN rather than leaving the inputs open.

Table 1. Main Temperature Data Register Format (00h, 01h)

| TEMP (°C)                      | DIGITAL OUTPUT |
|--------------------------------|----------------|
| +145                           | 1001 0001      |
| +130                           | 1000 0010      |
| +128                           | 1000 0000      |
| +25                            | 0001 1001      |
| 0                              | 0000 0000      |
| <0                             | 0000 0000      |
| Diode fault<br>(short or open) | 1111 1111      |

The DXP-DXN differential input voltage range is 0.25V to 0.95V. Excess resistance in series with the remote diode causes +0.5°C (typ) error per ohm.

## Remote Temperature Measurement Range

The MAX6646/MAX6647/MAX6649 measure remote temperatures significantly above the +120°C limit of many temperature sensors. External diode-connected transistors work well as temperature sensors up to approximately +145°C, where accuracy begins to degrade. Thermal diodes on some CPUs have characteristics that produce "apparent temperatures" far above actual operating temperatures. The MAX6646/MAX6647/MAX6649 measure apparent temperatures as high as +170°C, as long as the actual temperature is less than +145°C.

#### **A/D Conversion Sequence**

A conversion sequence consists of a local temperature measurement and a remote temperature measurement. Each time a conversion begins, whether initiated automatically in the free-running autonomous mode ( $\overline{\text{RUN}} = 0$ ) or by writing a one-shot command, both channels are converted, and the results of both measurements are available after the end of a conversion. A BUSY status bit in the status byte indicates that the device is performing a new conversion. The results of the previous conversion are always available, even if the ADC is busy.

#### **Low-Power Standby Mode**

Standby mode reduces the supply current to less than  $12\mu A$  by disabling the ADC and timing circuitry. Enter standby mode by setting the  $\overline{RUN}$  bit to 1 in the configuration byte register (Table 6). All data is retained in memory, and the SMBus interface is active and listening for SMBus commands. Standby mode is not a shutdown mode. With activity on the SMBus, the device draws more supply current (see *Typical Operating Characteristics*). In standby mode, the MAX6646/MAX6647/MAX6649 can be forced to perform A/D conversions through the one-shot command, regardless of the  $\overline{RUN}$  bit status.

If a standby command is received while a conversion is in progress, the conversion cycle is truncated, and the data from that conversion is not latched into a temperature register. The previous data is not changed and remains available.

Supply-current drain during the 125ms conversion period is 250µA (typ). Slowing down the conversion rate reduces the average supply current (see *Typical Operating Characteristics*). Between conversions, the conversion rate timer consumes 25µA (typ) of supply current. In standby mode, supply current drops to 3µA (typ).

#### **SMBus Digital Interface**

From a software perspective, the MAX6646/MAX6647/ MAX6649 appear as a set of byte-wide registers that contain temperature data, alarm threshold values, and control bits. A standard SMBus-compatible 2-wire serial interface is used to read temperature data and write control bits and alarm threshold data.

The MAX6646/MAX6647/MAX6649 employ four standard SMBus protocols: write byte, read byte, send byte, and receive byte (Figures 1, 2, and 3). The shorter receive byte protocol allows quicker transfers, provided that the correct data register was previously selected by a read byte instruction. Use caution when using the shorter protocols in multimaster systems, as a second master could overwrite the command byte without informing the first master.

Temperature data can be read from the read internal temperature (00h) and read external temperature (01h) registers. The temperature data format for these registers is 8 bits for each channel, with the LSB representing 1°C (Table 1). The MSB is transmitted first.

An additional 3 bits can be read from the read external extended temperature register (10h), which extends the data to 11 bits and the resolution to 0.125°C per LSB. An additional 3 bits can be read from the read internal extended temperature register (11h), which extends the data to 11 bits and the resolution to 0.125°C per LSB (Table 2).

When a conversion is complete, the main temperature register and the extended temperature register are updated simultaneously. Ensure that no conversions are completed between reading the main register and the extended register, so that both registers contain the result of the same conversion.

Table 2. Extended Resolution Temperature Register Data Format (10h, 11h)

| FRACTIONAL TEMP (°C) | DIGITAL OUTPUT |
|----------------------|----------------|
| 0.000                | 000X XXXX      |
| 0.125                | 001X XXXX      |
| 0.250                | 010X XXXX      |
| 0.375                | 011X XXXX      |
| 0.500                | 100X XXXX      |
| 0.625                | 101X XXXX      |
| 0.750                | 110X XXXX      |
| 0.875                | 111X XXXX      |

#### **Write Byte Format**

| S | ADDRESS | WR | ACK | COMMAND | ACK | DATA   | ACK | Р |
|---|---------|----|-----|---------|-----|--------|-----|---|
|   | 7 bits  |    |     | 8 bits  |     | 8 bits |     | 1 |

Slave Address: equivalent to chip-select line of a 3-wire interface Command Byte: selects which register you are writing to

Data Byte: data goes into the register set by the command byte (to set thresholds, configuration masks, and sampling rate)

#### **Read Byte Format**

| S | ADDRESS | WR | ACK | COMMAND | ACK | S | ADDRESS | RD | ACK | DATA   | /// | Р |
|---|---------|----|-----|---------|-----|---|---------|----|-----|--------|-----|---|
|   | 7 bits  |    |     | 8 bits  |     |   | 7 bits  |    |     | 8 bits |     |   |

Slave Address: equivalent to chip-select line

Command Byte: selects which register you are reading from

Slave Address: repeated due to change in dataflow direction Data Byte: reads from the register set by the command byte

#### **Send Byte Format**

| S | ADDRESS | WR | ACK | COMMAND | ACK | Р |
|---|---------|----|-----|---------|-----|---|
|   | 7 bits  |    |     | 8 bits  |     |   |

Command Byte: sends command with no data, usually used for one-shot command

S = Start condition Shaded = Slave transmission
P = Stop condition /// = Not acknowledged

#### Receive Byte Format

| S | ADDRESS | RD | ACK | DATA   | /// | Р |
|---|---------|----|-----|--------|-----|---|
|   | 7 bits  |    |     | 8 bits |     |   |

Data Byte: reads data from the register commanded by the last Read Byte or Write Byte transmission; also used for SMBus Alert Response return address

Figure 1. SMBus Protocols

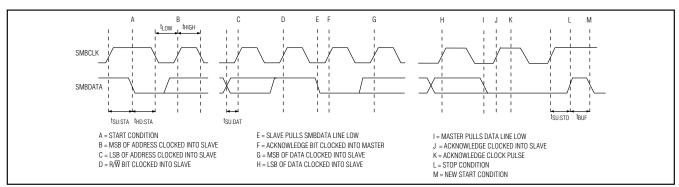


Figure 2. SMBus Write Timing Diagram

To ensure valid extended data, read extended resolution temperature data using one of the following approaches:

- Put the MAX6646/MAX6647/MAX6649 into standby mode by setting bit 6 of the configuration register to 1. Initiate a one-shot conversion using command byte 0Fh. When this conversion is complete, read the contents of the temperature data registers.
- 2) If the MAX6646/MAX6647/MAX6649 is in run mode, read the status byte. If the BUSY bit indicates that a conversion is in progress, wait until the conversion is complete (BUSY bit set to zero) before reading the temperature data. Following a conversion completion, immediately read the contents of the temperature data registers. If no conversion is in progress, the data can be read within a few microseconds, which is a sufficiently short period of time to ensure that a new conversion cannot be completed until after the data has been read.

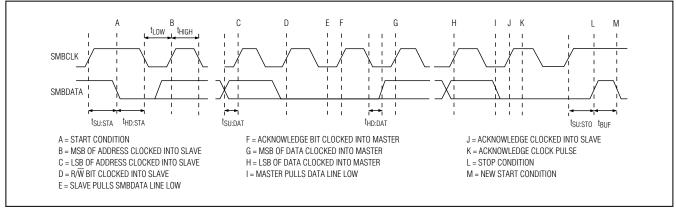


Figure 3. SMBus Read Timing Diagram

#### **Alarm Threshold Registers**

Four registers store ALERT threshold values—one high-temperature (T<sub>HIGH</sub>) and one low-temperature (T<sub>LOW</sub>) register each for the local and remote channels. If either measured temperature equals or exceeds the corresponding ALERT threshold value, the ALERT interrupt asserts.

The MAX6646/MAX6647 local (internal) ALERT THIGH register POR state is 0101 0101, or +85°C, while the remote (external) ALERT THIGH register POR state is 0101 1111, or +95°C. The MAX6649 POR state of both ALERT THIGH registers is 0101 0101, or +85°C. The POR state of the local and remote TLOW registers for all devices is 0000 0000, or 0°C.

Two additional registers store remote and local alarm threshold data corresponding to the OVERT output. The values stored in these registers are high-temperature thresholds. If either of the measured temperatures equals or exceeds the corresponding alarm threshold value, an OVERT output asserts. The MAX6646/MAX6647 local (internal) OVERT register POR state is 0101 0101, or +85°C, while the remote (external) OVERT register POR state is 0111 1101, or +125°C. The MAX6649 POR state of both OVERT registers is 0101 0101, or +85°C.

#### **Diode Fault Alarm**

A continuity fault detector at DXP detects an open circuit between DXP and DXN, or a DXP short to VCC, GND, or DXN. If an open or short circuit exists, the external temperature register is loaded with 1111 1111. If the fault is an open-circuit fault bit  $\underline{2}$  (OPEN), the status byte is set to 1. In the MAX6649,  $\overline{\text{ALERT}}$  is activated at the end of the conversion. Immediately after POR, the status register indicates that no fault is present. If a fault is present upon power-up, the fault is not indicated until the end of the first conversion.

#### **ALERT** Interrupts

The ALERT interrupt occurs when the internal or external temperature reading exceeds a high- or low-temperature limit (programmed) or in the MAX6649, when the remote diode is disconnected (for continuity fault detection). The ALERT interrupt output signal is latched and can be cleared only by either reading the status register or by successfully responding to an alert response address. In both cases, the alert is cleared if the fault condition no longer exists. Asserting ALERT does not halt automatic conversion. The ALERT output is open drain, allowing multiple devices to share a common interrupt line.

The MAX6646/MAX6647/MAX6649 respond to the SMBus alert response address, an interrupt pointer return-address feature (see the *Alert Response Address* section). Prior to taking corrective action, always check to ensure that an interrupt is valid by reading the current temperature.

#### Fault Queue Register

In some systems, it may be desirable to ignore a <u>single</u> temperature measurement that falls outside the <u>ALERT</u> limits. Bits 1 and 2 of the fault queue register (address 22h) determine the number of consecutive temperature faults necessary to set <u>ALERT</u> (see Tables 3 and 4).

#### **Alert Response Address**

The SMBus alert response interrupt pointer provides quick fault identification for simple slave devices that lack the complex, expensive logic needed to be a bus master. Upon receiving an ALERT interrupt signal, the host master can broadcast a receive byte transmission to the alert response slave address (0001 100). Following such a broadcast, any slave device that generated an interrupt attempts to identify itself by putting its own address on the bus.

Table 3. Fault Queue Register Bit Definition (22h)

| ` '      |              |   |   |  |
|----------|--------------|---|---|--|
| BIT NAME |              | POR<br>STATE                            | FUNCTION                                      |  |
| 7        | RFU          | 1                                       | Reserved. Always write 1 to this bit.         |  |
| 6 to 3   | RFU          | 0                                       | Reserved. Always write zero to this bit.      |  |
| 2        | FQ1          | Fault queue-length c bit (see Table 4). |   |  |
| 1        | FQ0          | 1                                       | Fault queue-length control bit (see Table 4). |  |
| 0        | I REU I () I |   | Reserved. Always write zero to this bit.      |  |

The alert response can activate several different slave devices simultaneously, similar to the I<sup>2</sup>C general call. If more than one slave attempts to respond, bus arbitration rules apply, and the device with the lower address code wins. The losing device does not generate an acknowledge and continues to hold the ALERT line low until cleared. (The conditions for clearing an ALERT vary, depending on the type of slave device). Successful completion of the read alert response protocol clears the interrupt latch, provided the condition that caused the alert no longer exists.

# **OVERT** Overtemperature Alarm/Warning Outputs

OVERT asserts when the temperature rises to a value stored in one of the OVERT limit registers (19h, 20h). It deasserts when the temperature drops below the stored limit, minus hysteresis. OVERT can be used to activate a cooling fan, send a warning, invoke clock throttling, or trigger a system shutdown to prevent component damage.

### **Command Byte Functions**

The 8-bit command byte register (Table 5) is the master index that points to the various other registers within the MAX6646/MAX6647/MAX6649. The register's POR state is 0000 0000, so a receive byte transmission (a protocol that lacks the command byte) that occurs immediately after POR, returns the current local temperature data.

The MAX6646/MAX6647/MAX6649 incorporate collision avoidance so that completely asynchronous operation is allowed between SMBus operations and temperature conversions.

**Table 4. Fault Queue Length Bit Definition** 

| FQ1 | FQ0 | FAULT QUEUE LENGTH (SAMPLES) |
|-----|-----|------------------------------|
| 0   | 0   | 1                            |
| 0   | 1   | 2                            |
| 1   | 1   | 3                            |
| 1   | 0   | 1                            |

#### **One-Shot**

The one-shot command immediately forces a new conversion cycle to begin. If the one-shot command is received while the MAX6646/MAX6647/MAX6649 are in standby mode (RUN bit = 1), a new conversion begins, after which the device returns to standby mode. If a one-shot conversion is in progress when a one-shot command is received, the command is ignored. If a one-shot command is received in autonomous mode (RUN bit = 0) between conversions, a new conversion begins, the conversion rate timer is reset, and the next automatic conversion takes place after a full delay elapses.

#### **Configuration Byte Functions**

The configuration byte register (Table 6) is a read-write register with several functions. Bit 7 is used to mask (disable) interrupts. Bit 6 puts the MAX6646/MAX6647/MAX6649 into standby mode (STOP) or autonomous (RUN) mode.

#### **Status Byte Functions**

The status byte register (Table 7) indicates which (if any) temperature thresholds have been exceeded. This byte also indicates whether the ADC is converting and whether there is an open-circuit fault detected in the external sense junction. After POR, the normal state of all flag bits is zero, assuming no alarm conditions are present. The status byte is cleared by any successful read of the status byte, after conversion is complete and if the fault condition no longer exists. Note that the ALERT interrupt latch is not automatically cleared when the status flag bit indicating the ALERT is cleared. The fault condition must be eliminated before the ALERT output can be cleared.

When autoconverting, if the T<sub>HIGH</sub> and T<sub>LOW</sub> limits are close together, it is possible for both high-temp and low-temp status bits to be set, depending on the amount of time between status read operations (especially when converting at the fastest rate). In these circumstances, it is best not to rely on the status bits to indicate reversals in long-term temperature changes. Instead use a current temperature reading to establish the trend direction.

Table 5. Command-Byte Bit Assignments

| REGISTER | ADDRESS | POR STATE |        | FUNCTION   |  |
|----------|---------|-----------|--------|--|--|
| RLTS     | 00h     | 0000 0000 | 0°C    | Read local (internal) temperature                          |  |
| RRTE     | 01h     | 0000 0000 | 0°C    | Read remote (external) temperature                         |  |
| RSL      | 02h     | N/A       | _      | Read status byte   |  |
| RCL      | 03h     | 0000 0000 | _      | Read configuration byte                                    |  |
| RCRA     | 04h     | 0000 0111 | _      | Read conversion rate byte                                  |  |
| RLHN     | 05h     | 0101 0101 | +85°C  | Read local (internal) ALERT high limit                     |  |
| RLLI     | 06h     | 0000 0000 | 0°C    | Read local (internal) ALERT low limit                      |  |
| RRHI     | 07h     | 0101 1111 | +95°C  | Read remote (external) ALERT high limit (MAX6646/MAX6647)  |  |
| NNI      | 0/11    | 0101 0101 | +85°C  | Read remote (external) ALERT high limit (MAX6649)          |  |
| RRLS     | 08h     | 0000 0000 | 0°C    | Read remote (external) ALERT low limit                     |  |
| WCA      | 09h     | N/A       | _      | Write configuration byte                                   |  |
| WCRW     | 0Ah     | N/A       | _      | Write conversion rate byte                                 |  |
| WLHO     | 0Bh     | N/A       | _      | Write local (internal) ALERT high limit                    |  |
| WLLM     | 0Ch     | N/A       | _      | Write local (internal) ALERT low limit                     |  |
| WRHA     | 0Dh     | N/A       | _      | Write remote (external) ALERT high limit                   |  |
| WRLN     | 0Eh     | N/A       | _      | Write remote (external) ALERT low limit                    |  |
| OSHT     | 0Fh     | N/A       | _      | One-shot   |  |
| REET     | 10h     | 0000 0000 | 0°C    | Read remote (external) extended temperature                |  |
| RIET     | 11h     | 0000 0000 | 0°C    | Read local (internal) extended temperature                 |  |
| RWOE     | 19h     | 0111 1101 | +125°C | Read/write remote (external) OVERT limit (MAX6646/MAX6647) |  |
| RWOE     | 1911    | 0101 0101 | +85°C  | Read/write remote (external) OVERT limit (MAX6649)         |  |
| RWOI     | 20h     | 0101 0101 | +85°C  | Read/write local (internal) OVERT limit                    |  |
| HYS      | 21h     | 0000 1010 | 10°C   | Overtemperature hysteresis                                 |  |
| QUEUE    | 22h     | 1000 0110 | _      | Fault queue  |  |
| _        | FEh     | 0100 1101 | _      | Read manufacture ID  |  |
| _        | FFh     | 0101 1001 | _      | Read revision ID   |  |

### Table 6. Configuration-Byte Bit Assignments (03h)

| BIT     | NAME | POR STATE | FUNCTION  |
|---------|------|-----------|---|
| 7 (MSB) | MASK | 0         | Masks ALERT interrupts when set to 1.                             |
| 6       | RUN  | 0         | Standby mode control bit; if set to 1, standby mode is initiated. |
| 5 to 0  | RFU  | 0         | Reserved.   |

#### **Conversion Rate Byte**

The conversion rate register (Table 8) programs the time interval between conversions in free-running autonomous mode ( $\overline{\text{RUN}} = 0$ ). This variable rate control can be used to reduce the supply current in portable-equipment applications. The conversion rate byte's POR state is 07h or 4Hz. The MAX6646/MAX6647/MAX6649 look only at the 3 LSBs of this register, so the upper 5 bits are "don't care" bits, which should be set to zero. The conversion rate tolerance is  $\pm 25\%$  at any rate setting.

Valid A/D conversion results for both channels are available two total conversion times (250ms nominal, 312ms maximum) after initiating a conversion, whether conversion is initiated through the RUN bit, one-shot command, or initial power-up. Changing the conversion rate can also affect the delay until new results are available.

Table 7. Status Register Bit Assignments (02h)

| BIT     | NAME  | POR<br>STATE | FUNCTION   |
|---------|-------|--------------|--|
| 7 (MSB) | BUSY  | 0            | A/D is busy converting when 1.   |
| 6       | LHIGH | 0            | Local (internal) high-temperature alarm has tripped when 1; cleared by POR or readout of the status byte if the fault condition no longer exists.  |
| 5       | LLOW  | 0            | Local (internal) low-temperature alarm has tripped when 1; cleared by POR or readout of the status byte if the fault condition no longer exists.   |
| 4       | RHIGH | 0            | Remote (external) high-temperature alarm has tripped when 1; cleared by POR or readout of the status byte if the fault condition no longer exists. |
| 3       | RLOW  | 0            | Remote (external) low-temperature alarm has tripped when 1; cleared by POR or readout of the status byte if the fault condition no longer exists.  |
| 2       | FAULT | 0            | A 1 indicates DXN and DXP are either shorted or open; cleared by POR or readout of the status byte if the fault condition no longer exists.        |
| 1       | EOT   | 0            | A 1 indicates the remote (external) junction temperature exceeds the external OVERT threshold.   |
| 0       | IOT   | 0            | A 1 indicates the local (internal) junction temperature exceeds the internal OVERT threshold.  |

#### **Slave Addresses**

The MAX6646/MAX6647/MAX6649 have fixed slave addresses (see Table 9). All devices also respond to the SMBus alert response slave address (see the *Alert Response Address* section).

#### **POR and UVLO**

To prevent ambiguous power-supply conditions from corrupting the data in memory and causing erratic behavior, a POR voltage detector monitors  $V_{CC}$  and clears the memory if  $V_{CC}$  falls below 2.0V (typ). When power is first applied and  $V_{CC}$  rises above 2.0V (typ), the logic blocks begin operating, although reads and writes at  $V_{CC}$  levels below 3V are not recommended. A second  $V_{CC}$  comparator, the ADC UVLO comparator, prevents the ADC from converting until there is sufficient headroom ( $V_{CC} = 2.7V$  typ).

#### **Power-Up Defaults**

Power-up defaults include:

- Interrupt latch is cleared.
- ADC begins autoconverting at a 4Hz rate.
- Command byte is set to 00h to facilitate quick local temperature receive byte queries.
- Local (internal) THIGH limit is set to +85°C.
- Local (internal) TLOW limit is set to 0°C.
- Remote (external) Thigh limit is set to +85°C (MAX6649)/+95°C (MAX6646/MAX6647)
- OVERT (internal) limit is set to +85°C
- OVERT (external) limit is set to +85°C (MAX6649)/ +125°C (MAX6646/MAX6647)

# Table 8. Conversion-Rate Control Byte (04h)

| -       |                         |
|---------|-------------------------|
| DATA    | CONVERSION<br>RATE (Hz) |
| 00h     | 0.0625                  |
| 01h     | 0.125                   |
| 02h     | 0.25                    |
| 03h     | 0.5                     |
| 04h     | 1                       |
| 05h     | 2                       |
| 06h     | 4                       |
| 07h     | 4                       |
| 08h-FFh | Reserved                |

#### **Table 9. Slave Addresses**

| PART    | SLAVE ADDRESS |  |
|---------|---------------|--|
| MAX6646 | 1001 101      |  |
| MAX6647 | 1001 110      |  |
| MAX6649 | 1001 100      |  |

### Applications Information

#### **Remote-Diode Selection**

The MAX6646/MAX6647/MAX6649 can directly measure the die temperature of CPUs and other ICs that have on-board temperature-sensing diodes (see *Typical Operating Circuit*), or they can measure the temperature of a discrete diode-connected transistor.

#### Effect of Ideality Factor

The accuracy of the remote temperature measurements depends on the ideality factor (n) of the remote "diode" (actually a transistor). The MAX6646/MAX6647/MAX6649 are optimized for n = 1.008, which is the typical value for the Intel® Pentium® III and the AMD Athlon MP model 6. If a sense transistor with a different ideality factor is used, the output data is different. Fortunately, the difference is predictable.

Assume a remote-diode sensor designed for a nominal ideality factor n<sub>NOMINAL</sub> is used to measure the temperature of a diode with a different ideality factor n<sub>1</sub>. The measured temperature T<sub>M</sub> can be corrected using:

$$T_{M} = T_{ACTUAL} \left( \frac{n_{1}}{n_{NOMINAL}} \right)$$

where temperature is measured in Kelvin.

As mentioned above, the nominal ideality factor of the MAX6646/MAX6647/MAX6649 is 1.008. The following example uses the MAX6646/MAX6647/MAX6649 with a CPU that has an ideality factor of 1.002. If the diode has no series resistance, the measured data is related to the real temperature as follows:

$$T_{ACTUAL} = T_{M} \left( \frac{n_{NOMINAL}}{n_{1}} \right) = T_{M} \left( \frac{1.008}{1.002} \right) = T_{M} (1.00599)$$

For a real temperature of +85°C (358.15 K), the measured temperature is +82.91°C (356.02 K), which is an error of -2.13°C.

#### Effect of Series Resistance

Series resistance in a sense diode contributes additional errors. For nominal diode currents of  $10\mu A$  and  $100\mu A$ , change in the measured voltage is:

$$\Delta V_{M} = R_{S}(100\mu A - 10\mu A) = 90\mu A \times R_{S}$$

Since 1°C corresponds to 198.6µV, series resistance contributes a temperature offset of:

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$$\frac{90\frac{\mu V}{\Omega}}{198.6\frac{\mu V}{^{\circ}C}} = 0.453\frac{^{\circ}C}{\Omega}$$

Assume that the diode being measured has a series resistance of  $3\Omega$ . The series resistance contributes an offset of:

$$3\Omega \times 0.453 \frac{^{\circ}\text{C}}{\Omega} = 1.36 ^{\circ}\text{C}$$

The effects of the ideality factor and series resistance are additive. If the diode has an ideality factor of 1.002 and series resistance of  $3\Omega$ , the total offset can be calculated by adding error due to series resistance with error due to ideality factor:

$$1.36^{\circ}\text{C} - 2.13^{\circ}\text{C} = -0.77^{\circ}\text{C}$$

for a diode temperature of +85°C.

In this example, the effect of the series resistance and the ideality factor partially cancel each other.

#### **Discrete Remote Diodes**

When the remote-sensing diode is a discrete transistor, short the collector to the base. Table 10 lists examples of discrete transistors that are appropriate for use with the MAX6646/MAX6647/MAX6649.

Avoid violating the A/D input voltage range by using a small-signal transistor with a relatively high forward voltage. The forward voltage at the highest expected temperature must be greater than 0.25V at 10µA, and the forward voltage at the lowest expected temperature must be less than 0.95V at 100µA. Do not use large power transistors. Ensure that the base resistance is less than 100 $\Omega$ . Tight specifications for forward current gain (50 < ß < 150, for example) indicate that the manufacturer has good process controls and that the devices have consistent VBE characteristics.

# Table 10. Remote-Sensor Transistor Manufactures

| MANUFACTURER                | MODEL NO.     |
|-----------------------------|---------------|
| Central Semiconductor (USA) | CMPT3904      |
| Rohm Semiconductor (USA)    | SST3904       |
| Samsung (Korea)             | KST3904-TF    |
| Siemens (Germany)           | SMBT3904      |
| Zetex (England)             | FMMT3904CT-ND |

**Note:** Discrete transistors must be diode connected (base shorted to collector).

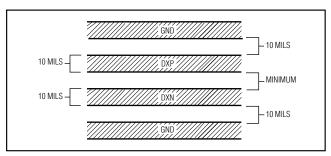


Figure 4. Recommended DXP-DXN PC Traces

#### **ADC Noise Filtering**

The integrating ADC used has good noise rejection for low-frequency signals such as 60Hz/120Hz power-supply hum. In noisy environments, high-frequency noise reduction is needed for high-accuracy remote measurements. The noise can be reduced with careful PC board layout and proper external noise filtering.

High-frequency EMI is best filtered at DXP and DXN with an external 2200pF capacitor. Larger capacitor values can be used for added filtering, but do not exceed 3300pF because larger values can introduce errors due to the rise time of the switched current source.

#### **PC Board Layout**

Follow these guidelines to reduce the measurement error of the temperature sensors:

- Place the MAX6646/MAX6647/MAX6649 as close as is practical to the remote diode. In noisy environments, such as a computer motherboard, this distance can be 4in to 8in (typ). This length can be increased if the worst noise sources are avoided. Noise sources include CRTs, clock generators, memory buses, and ISA/PCI buses.
- 2) Do not route the DXP-DXN lines next to the deflection coils of a CRT. Also, do not route the traces across fast digital signals, which can easily introduce 30°C error, even with good filtering.
- 3) Route the DXP and DXN traces in parallel and in close proximity to each other, away from any higher voltage traces, such as 12VDC. Leakage currents from PC board contamination must be dealt with carefully since a  $20M\Omega$  leakage path from DXP to ground causes about 1°C error. If high-voltage traces are unavoidable, connect guard traces to GND on either side of the DXP-DXN traces (Figure 4).
- 4) Route through as few vias and crossunders as possible to minimize copper/solder thermocouple effects.

- 5) When introducing a thermocouple, make sure that both the DXP and the DXN paths have matching thermocouples. A copper-solder thermocouple exhibits 3µV/°C, and takes about 200µV of voltage error at DXP-DXN to cause a 1°C measurement error. Adding a few thermocouples causes a negligible error.
- 6) Use wide traces. Narrow traces are more inductive and tend to pick up radiated noise. The 10mil widths and spacing recommended in Figure 4 are not absolutely necessary, as they offer only a minor improvement in leakage and noise over narrow traces. Use wider traces when practical.
- 7) Add a 200 $\Omega$  resistor in series with V<sub>CC</sub> for best noise filtering (see *Typical Operating Circuit*).
- 8) Copper cannot be used as an EMI shield; only ferrous materials such as steel work well. Placing a copper ground plane between the DXP-DXN traces and traces carrying high-frequency noise signals does not help reduce EMI.

#### **Twisted-Pair and Shielded Cables**

Use a twisted-pair cable to connect the remote sensor for remote-sensor distance longer than 8in, or in very noisy environments. Twisted-pair cable lengths can be between 6ft and 12ft before noise introduces excessive errors. For longer distances, the best solution is a shielded twisted pair like that used for audio microphones. For example, Belden 8451 works well for distances up to 100ft in a noisy environment. At the device, connect the twisted pair to DXP and DXN and the shield to GND. Leave the shield unconnected at the remote sensor.

For very long cable runs, the cable's parasitic capacitance often provides noise filtering, so the 2200pF capacitor can often be removed or reduced in value. Cable resistance also affects remote-sensor accuracy. For every  $1\Omega$  of series resistance, the error is approximately  $0.5^{\circ}\text{C}$ .

#### Thermal Mass and Self-Heating

When sensing local temperature, these devices are intended to measure the temperature of the PC board to which the devices are soldered. The leads provide a good thermal path between the PC board traces and the die. Thermal conductivity between the die and the ambient air is poor by comparison, making air temperature measurements impractical. Because the thermal mass of the PC board is far greater than that of the MAX6646/MAX6647/MAX6649, the device follows temperature changes on the PC board with little or no perceivable delay.

When measuring the temperature of a CPU or other IC with an on-chip sense junction, thermal mass has virtually no effect; the measured temperature of the junction tracks the actual temperature within a conversion cycle. When measuring temperature with discrete remote sensors, smaller packages, such as SC70s or SOT23s, yield the best thermal response times. Take care to account for thermal gradients between the heat source and the sensor, and ensure that stray air currents across the sensor package do not interfere with measurement accuracy.

Self-heating does not significantly affect measurement accuracy. Remote-sensor self-heating due to the diode current source is negligible. For the local diode, the worst-case error occurs when autoconverting at the fastest rate and simultaneously sinking maximum current at the  $\overline{\text{ALERT}}$  output. For example, with V<sub>CC</sub> = 5.0V, at a 4Hz conversion rate and with  $\overline{\text{ALERT}}$  sinking 1mA, the typical power dissipation is:

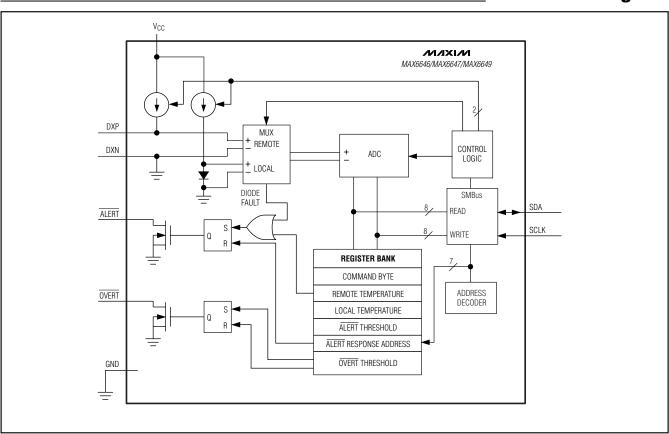
$$5.0V \times 500\mu A + 0.4V \times 1mA = 2.9mW$$

 $\mathcal{Q}_{J\text{-}A}$  for the 8-pin  $\mu$ MAX package is +221°C/W, so assuming no copper PC board heat sinking, the resulting temperature rise is:

$$\Delta T = 2.9 \text{mW} \times +221 ^{\circ} \text{C/W} = +0.6409 ^{\circ} \text{C}$$

Even under nearly worst-case conditions, it is difficult to introduce a significant self-heating error.

### **Functional Diagram**

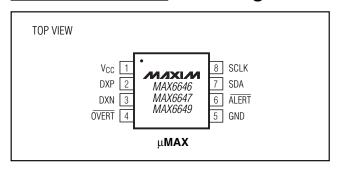


### **Selector Guide**

|         |          | POR V                        | ALUES  | ALERT ASSERTED<br>WHILE DIODE OPEN | PKG<br>CODE |
|---------|----------|------------------------------|--|------------------------------------|-------------|
| PART    | ADDRESS  | EXTERNAL OVERT<br>LIMIT (°C) | EXTERNAL ALERT<br>T <sub>HIGH</sub> LIMIT (°C) |                                    |             |
| MAX6646 | 1001 101 | +125                         | +95  | No                                 | U8-1        |
| MAX6647 | 1001 110 | +125                         | +95  | No                                 | U8-1        |
| MAX6649 | 1001 100 | +85                          | +85  | Yes                                | U8-1        |

### **Pin Configuration**

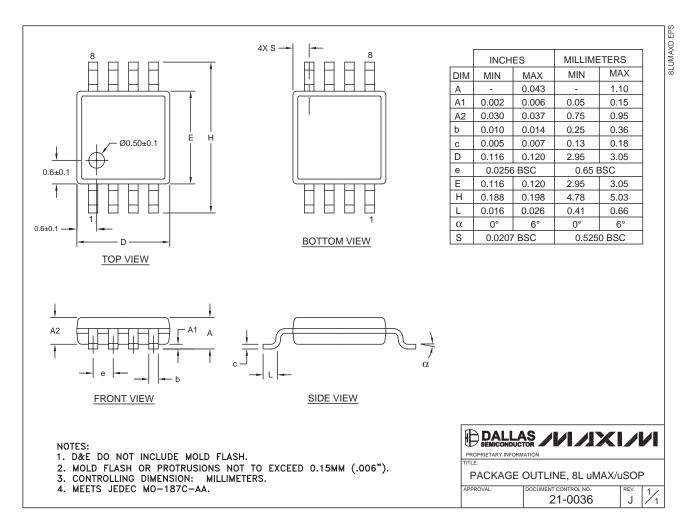
\_Chip Information



TRANSISTOR COUNT: 14,764 PROCESS: BICMOS

### Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



### \_Revision History

Pages changed at Rev 3: 1, 2, 9, 10, 15, 16

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